ASSOCIATION CONNEC	© Copyright 2005. IPC,	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Tyl Distribute													
upplier Info	rmation														
Company name*			Company uni	Company unique ID			Unique ID Authority					Response Date*			
nsemi												2024-05-16			
Contact Name Title - Contact				et		I	Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Pr				Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title -				Title - Representative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Reque	ester Item Number	Mfr Item	em Number Mfr Item Name				Effective Date	Version	M	Manufacturing Site		Weight*		UOM	Unit Type
		NV25080MUW2VTA G		8KB SPI SER CMOS EEPROM UDFN WETTABLE FLANKS		UDFN	2024-05-16		T	ГН6		9.28		mg	Each
<b>Ianufacturin</b>	ng Proccess Information	1													
Termin	Terminal Plating / Grid Array Material		Terminal Base Alloy J-		J-STD-020 MSL	D-020 MSL Rating		Peak Process Body Temperature		e Max Time at Peak Tempera		ature	ture Number of Reflow Cycles		eles
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		u) (no C	CU Alloy 1		1		260		C 3		seco	onds	3		
Comments															
vel 1 - maximur	m time at peak temperature o	luring sol	dering is 10-3	0 seconds											
or more inform	ation regarding material con	position	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.116	mg	Supplier	Silicon (Si)	7440-21-3		0.116	mg
Die Attach Tape	0.055	mg	Supplier	Silicon Dioxide	7631-86-9		0.0275	mg
			Supplier	Acrylic AE Copolymer	58152-79-7		0.0082	mg
			Supplier	Formaldehyde, polymer with 4,4-(1-methylethylidene)bisphenol	25085-75-0		0.0077	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0038	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0077	mg
Lead Frame	2.96	mg	Supplier	Tin (Sn)	7440-31-5		0.0074	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0065	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0074	mg
			Supplier	Copper (Cu)	7440-50-8		2.9387	mg
Mold Compound-Black	5.725	mg		Epoxy resin	proprietary data		0.2862	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1317	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2862	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0229	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1317	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.8663	mg
Plating	0.057	mg	Supplier	Palladium (Pd)	7440-05-3		0.0035	mg
			В	Nickel (Ni)	7440-02-0		0.0528	mg
			Supplier	Gold (Au)	7440-57-5		0.0006	mg
Plating-Sn	0.307	mg	Supplier	Tin (Sn)	7440-31-5		0.307	mg
Wire Bond - Au	0.06	mg	Supplier	Gold (Au)	7440-57-5		0.06	mg